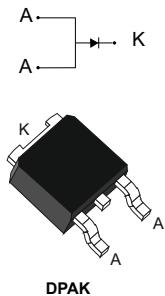


## Automotive 300 V, 10 A high efficiency ultrafast diode



### Features



- AEC-Q101 qualified
- Ultrafast recovery
- Low power losses
- High surge capability
- Low leakage current
- High junction temperature
- ECOPACK2 compliant

### Applications

- DC/DC converter
- Reverse battery protection
- Battery management system
- Audio amplification

Product status links	
<a href="#">STTH1003S-Y</a>	

Product summary	
$I_{F(AV)}$	10 A
$V_{RRM}$	300 V
$T_j(\text{max.})$	175 °C
$V_F(\text{typ.})$	0.9 V
$T_{rr(\text{max.})}$	13 ns

### Description

This **STTH1003S-Y** is an ultrafast recovery power rectifier dedicated to energy recovery in automotive applications.

This **STTH1003S-Y** is also intended for the clamping function in an energy recovery block.

The compromise between forward voltage drop and recovery time offers optimized performances.

## 1 Characteristics

**Table 1. Absolute ratings (limiting values, at 25 °C, unless otherwise specified)**

Symbol	Parameter	Value	Unit	
V <sub>RRM</sub>	Repetitive peak reverse voltage, T <sub>j</sub> = -40 °C to +175 °C	300	V	
I <sub>F(RMS)</sub>	Forward rms current	20	A	
I <sub>F(AV)</sub>	Average forward current, δ = 0.5, square wave	T <sub>C</sub> = 150 °C	10	A
I <sub>FSM</sub>	Surge non repetitive forward current	t <sub>p</sub> = 10 ms sinusoidal	100	A
T <sub>stg</sub>	Storage temperature range	-65 to +175	°C	
T <sub>j</sub>	Operating junction temperature range	-40 to +175	°C	

**Table 2. Thermal parameters**

Symbol	Parameter	Maximum value	Unit
R <sub>th(j-c)</sub>	Junction to case	4	°C/W

For more information, please refer to the following application note :

- AN5088 : Rectifiers thermal management, handling and mounting recommendations

**Table 3. Static electrical characteristics**

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage current	T <sub>j</sub> = 25 °C	V <sub>R</sub> = V <sub>RRM</sub>	-		10	µA
		T <sub>j</sub> = 125 °C		-	10	100	
V <sub>F</sub> <sup>(2)</sup>	Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 10 A	-		1.30	V
		T <sub>j</sub> = 125 °C		-	0.90	1.10	

1. Pulse test: t<sub>p</sub> = 5 ms, δ < 2%

2. Pulse test: t<sub>p</sub> = 380 µs, δ < 2%

To evaluate the conduction losses, use the following equation:

$$P = 0.86 \times I_{F(AV)} + 0.024 \times I_F^2 \text{ (RMS)}$$

For more information, please refer to the following application notes related to the power losses:

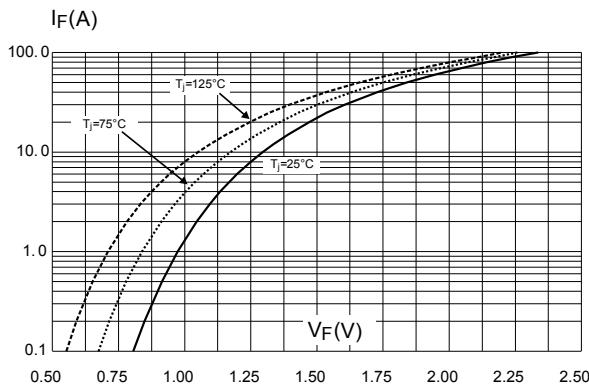
- AN604: Calculation of conduction losses in a power rectifier
- AN5028: Calculation of turn-off power losses generated by an ultrafast diode

**Table 4. Dynamic electrical characteristics**

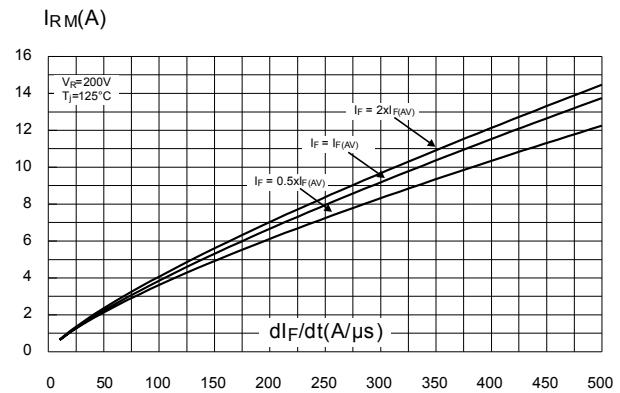
Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
t <sub>rr</sub>	Reverse recovery time	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 0.5 A, I <sub>rr</sub> = 0.25 A, I <sub>R</sub> = 1 A	-	13	17	ns
			I <sub>F</sub> = 1 A, V <sub>R</sub> = 30 V, dI <sub>F</sub> /dt = -50 A/µs	-	28	35	
I <sub>RM</sub>	Reverse recovery current	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 10 A, V <sub>R</sub> = 200 V, dI <sub>F</sub> /dt = 200 A/µs	-	5.7	7.5	A
			I <sub>F</sub> = 10 A, V <sub>R</sub> = 200 V, dI <sub>F</sub> /dt = 200 A/µs	-	0.3		-
Sfactor	Softness factor	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 10 A, V <sub>FR</sub> = 1.1 × V <sub>Fmax</sub> , dI <sub>F</sub> /dt = 100 A/µs			200	ns
			I <sub>F</sub> = 10 A, dI <sub>F</sub> /dt = 100 A/µs		2.5	3.5	V
t <sub>fr</sub>	Forward recovery time	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 10 A, V <sub>FR</sub> = 1.1 × V <sub>Fmax</sub> , dI <sub>F</sub> /dt = 100 A/µs			200	ns
			I <sub>F</sub> = 10 A, dI <sub>F</sub> /dt = 100 A/µs		2.5	3.5	V
V <sub>FP</sub>	Forward recovery voltage	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 10 A, V <sub>FR</sub> = 1.1 × V <sub>Fmax</sub> , dI <sub>F</sub> /dt = 100 A/µs			200	ns
			I <sub>F</sub> = 10 A, dI <sub>F</sub> /dt = 100 A/µs		2.5	3.5	V

## 1.1 Characteristics (curves)

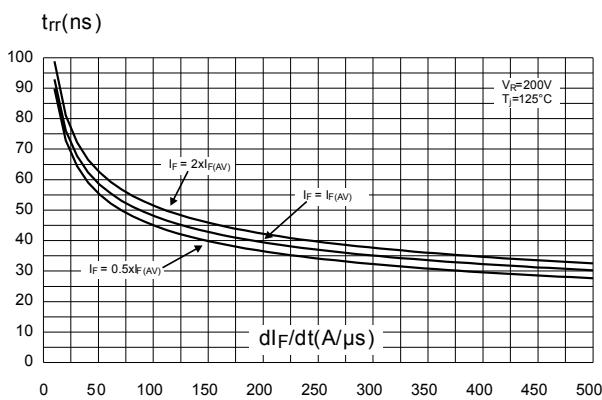
**Figure 1. Forward voltage drop versus current (maximum values)**



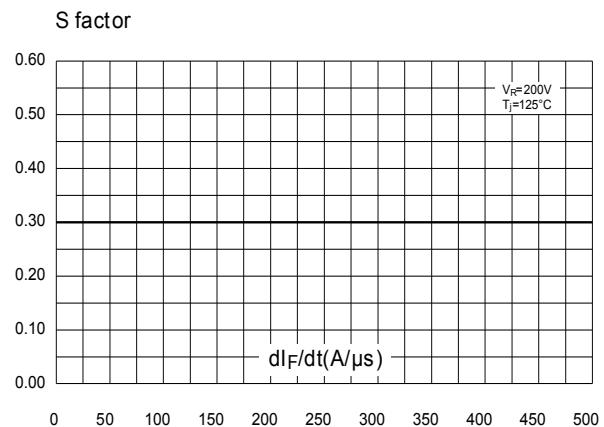
**Figure 2. Peak reverse recovery current versus  $dI_F/dt$  (90% confidence)**



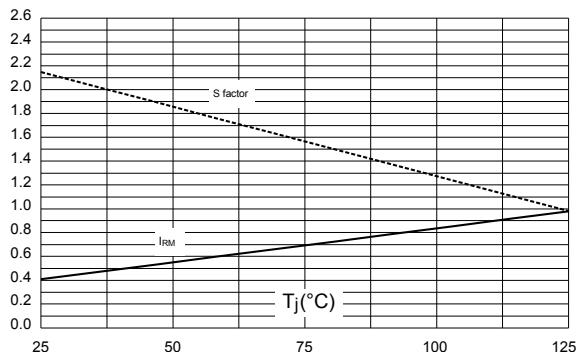
**Figure 3. Reverse recovery time versus  $dI_F/dt$  (90 % confidence)**



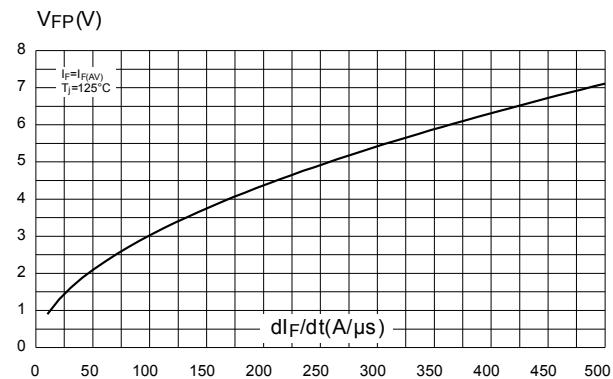
**Figure 4. Softness factor versus  $dI_F/dt$  (typical values)**



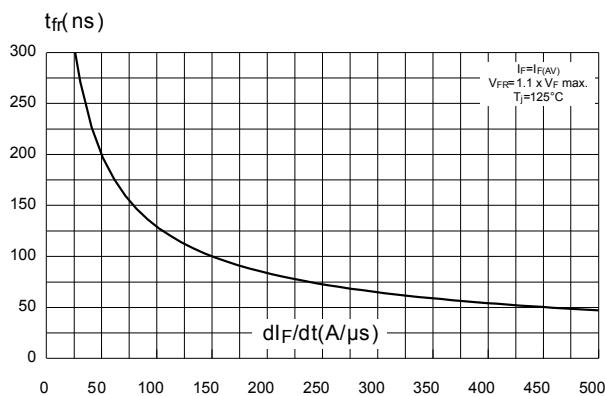
**Figure 5. Relative variations of dynamic parameters versus junction temperature (reference:  $T_j = 125^\circ\text{C}$ )**



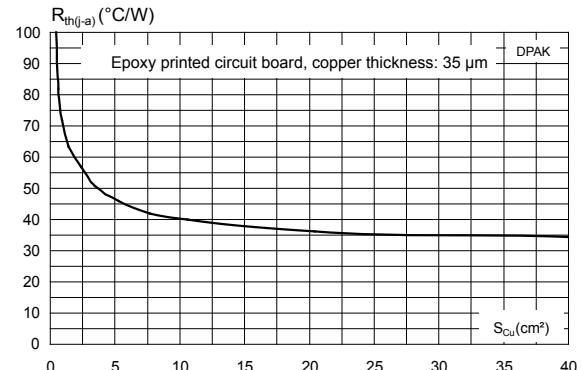
**Figure 6. Transient peak forward voltage versus  $\text{d}I_F/\text{dt}$  (90% confidence)**



**Figure 7. Forward recovery versus  $\text{d}I_F/\text{dt}$  (90% confidence)**



**Figure 8. Thermal resistance junction to ambient versus copper surface under tab (typical values)**



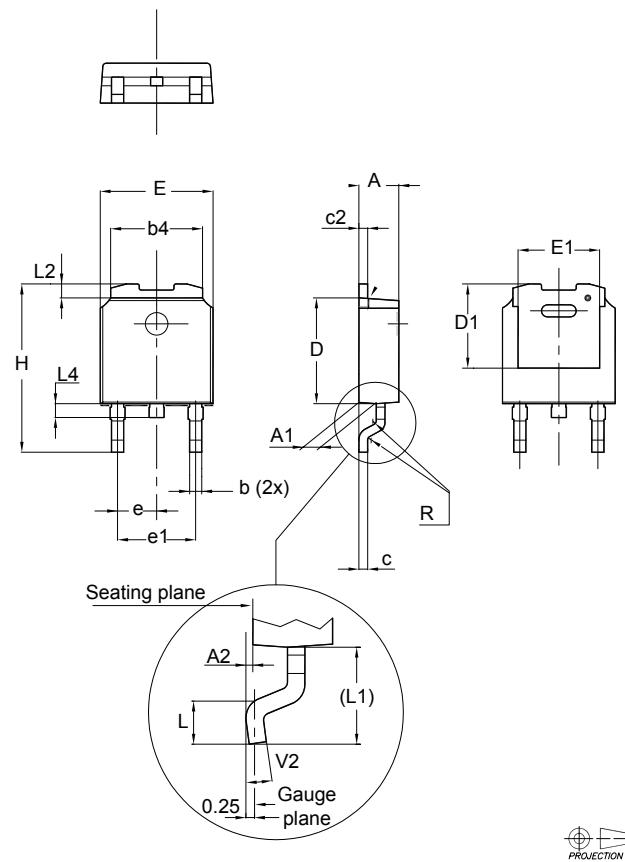
## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 2.1 DPAK package information

- Epoxy meets UL94, V0

Figure 9. DPAK package outline



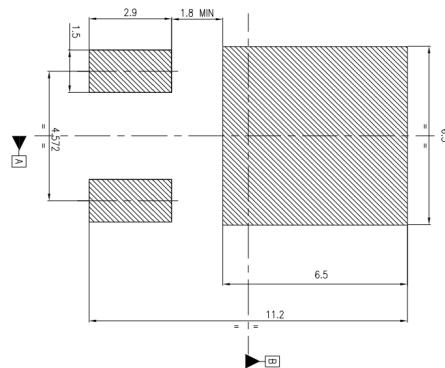
**Note:** This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 5. DPAK mechanical data

Dim.	Dimensions					
	Millimeters			Inches <sup>(1)</sup>		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.20		2.40	0.087		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
b	0.64		0.90	0.025		0.035
b4	5.20		5.40	0.205		0.213
c	0.45		0.60	0.018		0.024
c2	0.48		0.60	0.019		0.024
D	6.00		6.20	0.236		0.244
D1	4.95	5.10	5.25	0.195	0.201	0.207
E	6.40		6.60	0.252		0.260
E1	4.60	4.70	4.80	0.181	0.185	0.189
e	2.159	2.286	2.413	0.085	0.090	0.095
e1	4.445	4.572	4.699	0.175	0.180	0.185
H	9.35		10.10	0.368		0.398
L	1.00		1.50	0.039		0.059
(L1)	2.60	2.80	3.00	0.102	0.110	0.118
L2	0.65	0.80	0.95	0.026	0.031	0.037
L4	0.60		1.00	0.024		0.039
R		0.20			0.008	
V2	0°		8°	0°		8°

1. Inches dimensions given for reference only

Figure 10. DPAK recommended footprint (dimensions are in mm)



Note: For package and tape orientation, reel and inner box dimensions and tape outline please check [TN1173](#)

### 3 Ordering information

Table 6. Order code

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH1003SBY-TR	TH10 03SBY	DPAK	0.32 g	2500	Tape and reel

## Revision history

**Table 7. Document revision history**

Date	Revision	Changes
24-Oct-2012	1	Initial release.
28-Jan-2019	2	Added <i>Section Applications</i> . Updated <i>Table 6</i> . Added <i>Figure 8</i> .
03-Jun-2024	3	Updated package view on cover page.

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